

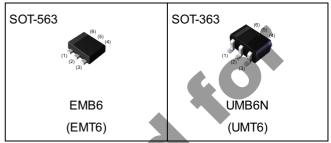
General purpose (dual digital transistor)

Parameter	DTr1 and DTr2
V _{CC}	-50V
I _{C(MAX.)}	-100mA
R ₁	47kΩ
R ₂	47kΩ

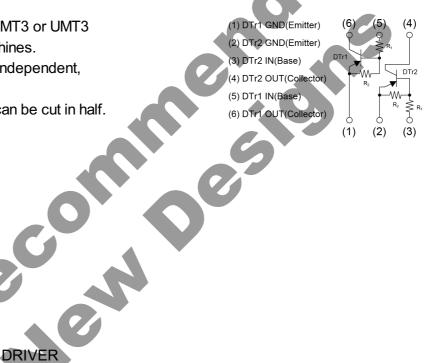
Features

- 1)Two DTA144E chips in a EMT or UMT package.
- 2)Mounting possible with EMT3 or UMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.
- 4) Mounting cost and area can be cut in half.

Outline



Inner circuit



Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMB6	SOT-563 (EMT6)	1616	T2R	180	8	8000	В6
UMB6N	SOT-363 (UMT6)	2021	TR	180	8	3000	B6

● Absolute maximum ratings (T_a = 25°C)

<For DTr1 and DTr2 in common>

Parameter			Symbol	Values	Unit	
Supply voltage			V_{CC}	-50	V	
Input voltage			V _{IN}	-40 to 10	V	
Output current			Io	-30	mA	
Collector current			I _{C(MAX)} *1	-100	mA	
Deven dississis	EMB6		P _D *2*3	150	mW/Tota	
Power dissipation	UMB6N		P _D *2*3	150		
Junction temperature			Tj	150	°C	
Range of storage temperat	ure		T _{stg}	-55 to +150	°C	
●Electrical characteristic <for and="" dtr1="" dtr2="" in<="" td=""><td>, ~</td><td></td><td></td><td></td><td></td></for>	, ~					

● Electrical characteristics (T_a = 25°C)

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Parameter	Symbol	Conditions			Values	
r ai ai nietei	Symbol		Min.	Тур.	Max.	Unit
Input voltage	$V_{l(off)}$	$V_{CC} = -5V, I_{O} = -100 \mu A$	-	-	-0.5	V
	V _{I(on)}	$V_O = -0.3V$, $I_O = -2mA$	-3.0	-	-	V
Output voltage	V _{O(on)}	$I_{Q} = -10 \text{mA}, I_{I} = -0.5 \text{mA}$	-	-100	-300	mV
Input current	I	V ₁ = -5V	-	-	-180	μA
Output current	I _{O(off)}	$V_{CC} = -50V, V_{I} = 0V$	-	-	-500	nA
DC current gain	G	$V_{O} = -5V, I_{O} = -5mA$	68	-	-	1
Input resistance	R_1	-	32.9	47	61.1	kΩ
Resistance ratio	R ₂ /R ₁	-	0.8	1.0	1.2	-
Transition frequency	f _T *1	V _{CE} = -10V, I _E = 5mA, f = 100MHz	-	250	-	MHz

^{*1} Characteristics of built-in transistor.

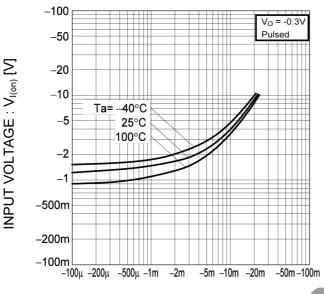
^{*2} Each terminal mounted on a reference land.

^{*3 120}mW per element must not be exceeded.

● Electrical characteristic curves (T_a = 25°C)

<For DTr1 and DTr2 in common>

Fig.1 Input Voltage vs. Output Current (ON Characteristics)



OUTPUT CURRENT : Io [A]

Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

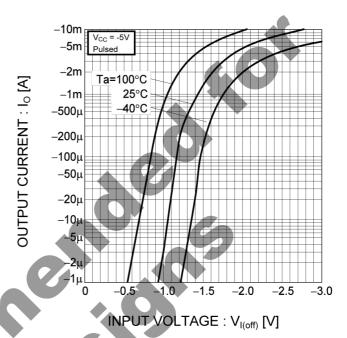


Fig.3 Output Current vs. Output Voltage

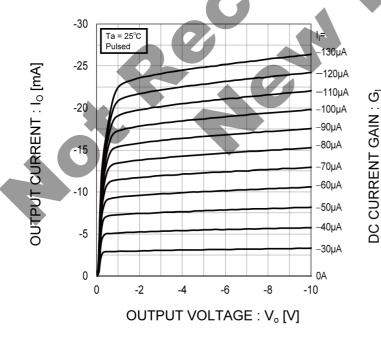
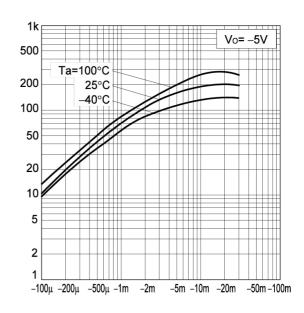


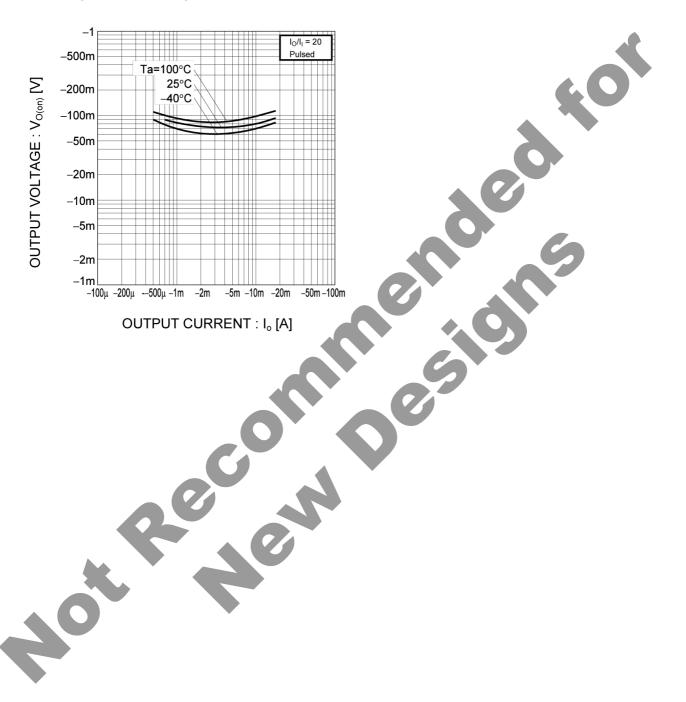
Fig.4 DC Current Gain vs. Output Current



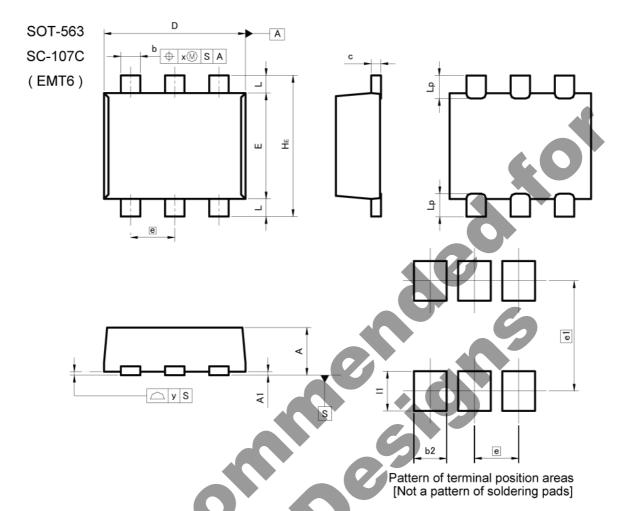
●Electrical characteristic curves (T_a = 25°C)

<For DTr1 and DTr2 in common>

Fig.5 Output Voltage vs. Output Current



Dimensions

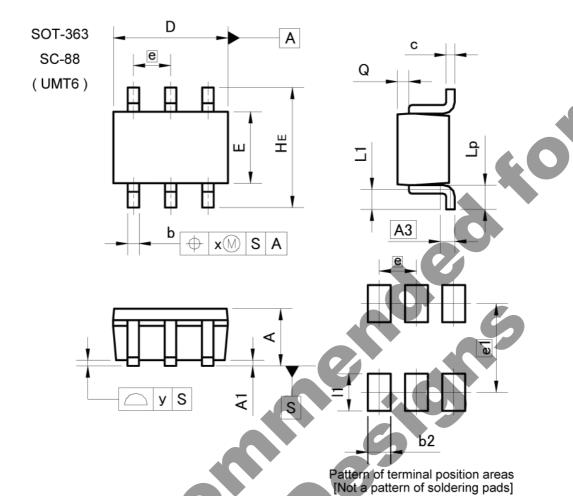


DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
A	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
C	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	1.10	1.30	0.043	0.051	
е	0.	50	0.020		
HE	1.50	1.70	0.059	0.067	
L	0.10	0.30	0.004	0.012	
Lp	_	0.35	-	0.014	
х	_	0.10		0.004	
у	_	0.10	-	0.004	

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DIM	MILIMETERS		INCHES		
DIM	MIN MAX		MIN	MAX	
b2	_	0.37	-	0.015	
e1	1.25		0.0	49	
- 11	-	0.45	-	0.018	

Dimension in mm/inches

Dimensions



DIM	MILIM	ETERS	INCHES		
DIW	MIN	MAX	MIN	MAX	
A	0.80	1.00	0.031	0.039	
(A1	0.00	0.10	0.000	0.004	
A3	0.3	25	0.010		
b	0.15	0.30	0.006	0.012	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.	65	0.026		
HE	2.00	2.20	0.079	0.087	
L1	0.20	0.50	0.008	0.020	
Lp	0.25	0.55	0.010	0.022	
Q	0.10	0.30	0.004	0.012	
х	-	0.10	-	0.004	
У	-	0.10	(C 	0.004	

DIM	MILIMETERS		INCHES		
DIM	MIN MAX		MIN	MAX	
b2	- 7	0.40	-	0.016	
e1	1.55		0.0	61	
11		0.65	-	0.026	

Dimension in mm/inches

Notice

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(Note1) Medical Equipment Classification of the Specific Applications

	JAPAN	USA	EU	CHINA
Ī	CLASSⅢ	CLACCIII	CLASS II b	СГУССШ
	CLASSIV	CLASSⅢ	CLASSⅢ	CLASSII

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl2, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power, exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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